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Customer No.: 31561 Docket No.: 13050-US-PA

Application No.: 10/709,468

## <u>AMENDMENT</u>

## In the Claims:

Claims 1-15 (cancelled)

Claim 16 (new) A speaker module with a built-in front sound enclosure and a built-in rear sound enclosure, for installing in a handheld electronic device, comprising:

a speaker module frame, comprising a main portion having an accommodating hole, an extending portion and a protruding portion, wherein the main portion having an accommodating hole, the accommodating hole accommodating a speaker vibration system and a magnetic loop, and wherein the protruding portion disposed around the main portion and the extending portion;

a front cover, disposed at a first side of the speaker module frame, the built-in front sound enclosure being formed between the front cover and the speaker vibration system, the front cover having a plurality of tone holes; and

a rear cover, disposed at a second side of said main portion, the second side being opposite to the first side, the built-in rear sound enclosure being formed between the rear cover and the main portion, wherein the height of the protruding portion depends on the characteristics of the speaker vibration system and the magnetic loop in order to provide the built-in front sound enclosure.

Claim 17 (new) The speaker module of claim 16, wherein the main portion includes a plurality of positioning slices extending from a sidewall of the accommodating hole to a center of the accommodating hole for positioning the speaker vibration system and the magnetic loop.

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Claim 18 (new) The speaker module of claim 16, wherein the speaker vibration

system is a vibration film having a coil.

Claim 19 (new) The speaker module of claim 16, wherein the speaker module

frame is one piece structure formed by plastic injection molding.

Claim 20 (new) An electronic device at least comprising a speaker module with a

built-in front sound enclosure and a built-in rear sound enclosure, said speaker module

including:

a speaker module frame, comprising a main portion having an accommodating

hole, an extending portion and a protruding portion, wherein the main portion having an

accommodating hole, the accommodating hole accommodating a speaker vibration

system and a magnetic loop, and wherein the protruding portion disposed around the

main portion and the extending portion;

a front cover, disposed at a first side of the speaker module frame, the built-in

front sound enclosure being formed between the front cover and the speaker vibration

system, the front cover having a plurality of tone holes; and

a rear cover, disposed at a second side of said main portion, the second side being

opposite to the first side, the built-in rear sound enclosure being formed between the rear

cover and the main portion, wherein the height of the protruding portion depends on the

characteristics of the speaker vibration system and the magnetic loop in order to provide

the built-in front sound enclosure.

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